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CLAIMS

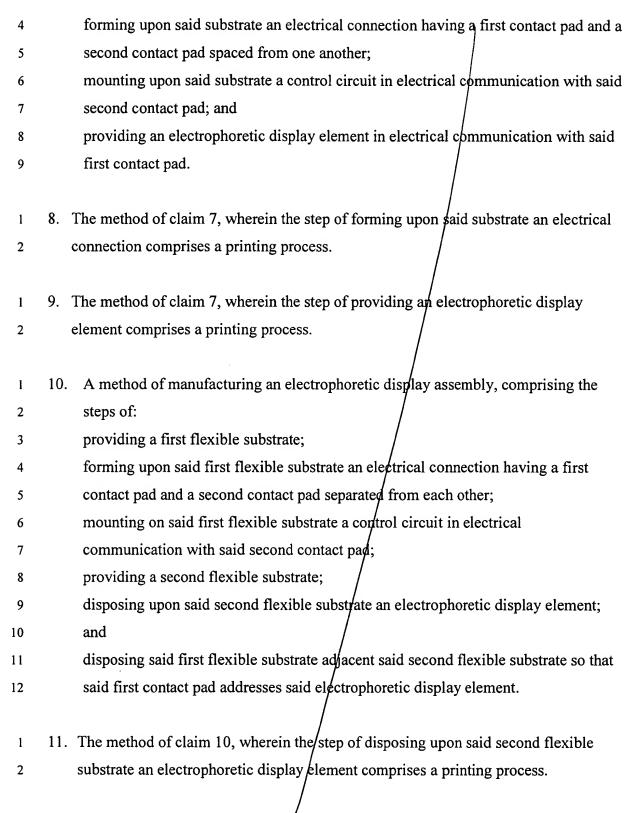
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- A mounted electrophoretic display assembly, comprising:
 - a flexible substrate;
 - an electrical connection formed on said flexible substrate and having first and
- second contact pads spaced from one another;
- an electrophoretic display element in electrical communication with said first 5
- contact pad; and
- a control circuit mounted on said flexible substrate and in electrical communication 7
- with said second contact pad. 8
- 2. The display assembly of claim 1, wherein said control circuit is connected to said 1 second contact pad with a curable, electrically conductive thermoset. 2
- 3. The display assembly of claim 1, wherein said control circuit is connected to said 1 second contact pad with an electrically conductive ink. 2
- 4. The display assembly of claim 1, wherein said control circuit is connected to said 1 2 second contact pad with an electrically conductive paint.
- 5. The display assembly of claim 1, wherein said control circuit is connected to said
- second contact pad by being removably mounted in a control circuit carrier that is in 2
- 3 electrical communication with said second contact pad.
- 6. The display assembly of claim 1 wherein said control circuit comprises an 1
- electrophoretic display driver chip. 2
- A method of manufacturing an electrophoretic display assembly, comprising the steps 1
- 2 of:
- providing a flexible substrate; 3

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12. The method of claim 10, wherein the step of disposing said first flexible substrate adjacent said second flexible substrate further comprises a laminating process.